



IMX8

DUAL NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

Epitaxial Planar Die Construction

Complementary PNP Type Available (IMT4)

Small Surface Mount Package

Lead Free/RoHS Compliant (Note 3)

"Green" Device, Note 4 and 5

Mechanical Data

Case: SOT-26

Case Material: Molded Plastic, "Green" Molding

Compound, Note 5. UL Flammability

Classification 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminal Connections: See Diagram

Terminals: Solderable per MIL-STD-202, Method 208

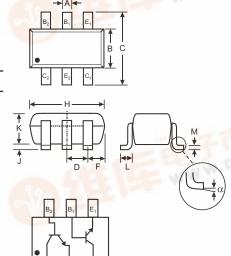
Lead Free Plating (Matte Tin Finish annealed over

Copper leadframe).

Marking (See Page 2): KX8

Ordering & Date Code Information: See Page 2

Weight: 0.016 grams (approximate)



SOT-26									
Dim	Min	Max	Тур						
Α	0.35	0.50	0.38						
В	1.50	1.70	1.60						
С	2.70	3.00	2.80						
D			0.95						
F			0.55						
Н	2.90	3.10	3.00						
J	0.013	0.10	0.05						
K	1.00	1.30	1.10						
L	0.35	0.55	0.40						
M	0.10	0.20	0.15						
	0	8°							
All Dimensions in mm									

Maximum Ratings @ T_A = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V_{CBO}	120	ISC. CV	
Collector-Emitter Voltage	V _{CEO}	120	V	
Emitter-Base Voltage	V _{EBO}	5.0	V	
Collector Current - Continuous	Ic	50	mA	
Power Dissipation (Note 1)	P _d	300	mW	
Thermal Resistance, Junction to Ambient (Note 1)	R _{JA}	417	C/W	
Operating and Storage and Temperature Range	T _j , T _{STG}	-55 to +150	С	

Electrical Characteristics @ TA = 25 C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition				
OFF CHARACTERISTICS (Note 2)										
Collector-Base Breakdown Voltage	V _{(BR)CBO}	120		- 63	V	I _C = 50 A				
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	120	- 41	1	V	I _C = 1.0mA				
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	5.0	1772 E-	CIL P	V	I _E = 50 A				
Collector Cutoff Current	Ісво	- 10	W/	0.5	А	V _{CB} = 100V				
Emitter Cutoff Current	I _{EBO}			0.5	Α	V _{EB} = 4.0V				
ON CHARACTERISTICS (Note 2)										
DC Current Gain	h _{FE}	180		820		I _C = 2.0mA, V _{CE} = 6.0V				
Collector-Emitter Saturation Voltage	V _{CE(SAT)}			0.5	V	I _C = 10mA, I _B = 1.0mA				
SMALL SIGNAL CHARACTERISTICS										
Current Gain-Bandwidth Product	f _T		140		MHz	V _{CE} = 12V, I _C = 2.0mA, f = 100MHz				

1. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 200mW per element must not be exceeded. Short duration test pulse used to minimize self-heating effect.

No purposefully added lead.

4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php. SC.COI5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.





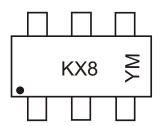
Ordering Information (Note 5 & 6)

Device	Packaging	Shipping		
IMX8-7-F	SOT-26	3000/Tape & Reel		

Notes: 5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

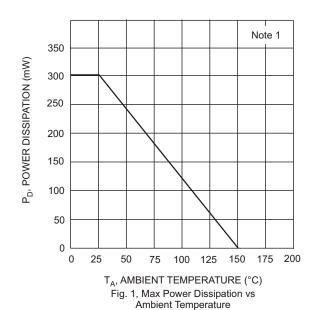
Marking Information



KX8 = Product Type Marking Code YM = Date Code Marking Y = Year ex: T = 2006 M = Month ex: 9 = September

Date Code Key

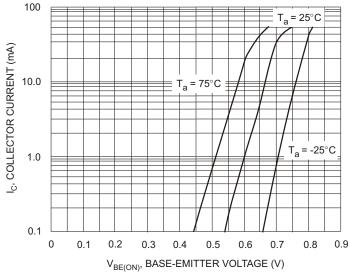
Year	2002	2003	2004	2005	2006	2007	'	2008	2009	20	010	2011	2012
Code	N	Р	R	S	Т	U		V	W		Х	Υ	Z
IV	Month Ja		an F	eb Ma	ar Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
	Code		1	2 3	4	5	6	7	8	9	0	N	D



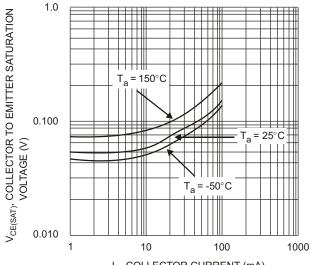
 $T_a = 75^{\circ}C$ $T_a = 75^{\circ}C$ $T_a = 25^{\circ}C$ $T_a = -25^{\circ}C$ $T_a = -25^{\circ}C$

Fig. 2 Typical DC Current Gain vs. Collector Current

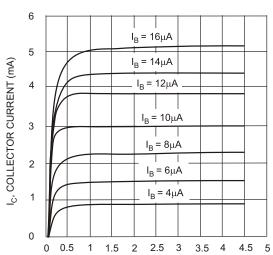




V_{BE(ON)}, BASE-EMITTER VOLTAGE (\) Fig. 3 Typical Collector Current vs. Base-Emitter Voltage



I_C, COLLECTOR CURRENT (mA) Fig. 4 Typical Collector-Emitter Voltage vs. Collector Current



V_{CE}, COLLECTOR-EMITTER VOLTAGE (V) Fig. 6 Typical Collector Current vs. Collector-Emitter Voltage

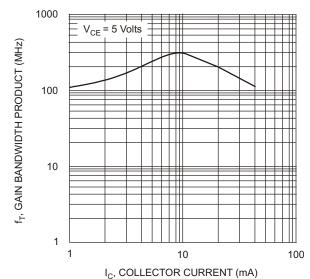


Fig. 5 Typical Gain Bandwidth Product vs. Collector Current



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